Harvatek Surface Mount CHIP LEDs Data Sheet Model: HT-V116BP

Acknowledged by

Section Manager

Production Engineering Dept.

Manager

Production Engineering Dept.

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Tentative Product	*******	******	HDS-V116-K336	
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Introduction

- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by HARVATEK for any infringements of intellectual property or other rights of the third parties which may result from it use.
- HARVATEK is continually making an effort to improve the quality of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing HARVATEK products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such HARVATEK products cause loss of human life, bodily injury or damage to property.
- The HARVATEK products listed in this document are intended for usage in general electronics (computer, personal equipment, office equipment, industrial robotics, domestic, etc...) These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury.
- In developing your designs, please ensure that HARVATEK products are used within specified operating ranges as set forth in the most recent HARVATEK products specifications.
- Also, please keep in mind the precautions listed in this document.

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Product Specification

	Specification	Material	Quantity
lv	500-1270mcd		
	@20mA/ Ta= 25 ^o C		
	Tolerance: ± 10%		
Chromaticity	Refer to page 8		
Coordinates	@20mA/ Ta= 25 ^o C		
	Tolerance: ± 0.01		
Vf	2.7~3.7V		
	@20mA/ Ta= 25 ^o C		
	Tolerance: + 0.05V		
Resin	Yellow	Silicone resin	
Carrier tape	According to EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	According to EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified
	Specification	Material	Quantity

Others:

Every mid-box will be loaded 5 reels. These 5 reels can be different in lot, Iv, lambda, or Vf. Every reel will have an independent label to identify its specification and the mid-box there will have a corresponding label post on it.

ATTENTION: Electric static Discharge (ESD) protection



The symbol shown on the page herein to introduce 'Electro-Optical

Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built with AlInGaP,

GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD protection has to considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

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Product Characteristics

Electro-Optical Characteristics

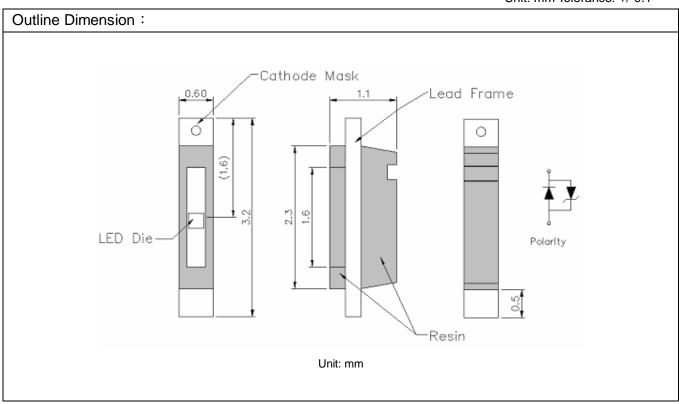
(I_F @ 20mA, T_a 25 °C)

(IF © 2011) II 1a 20 0)										
Product No. Lighting Color	Lighting Color N	Material	V _F (V)		λ (nm)			I [*] _V (mcd)		
		min	max	λo	λр	Δλ	min	typ	max	
HT-V116BP	White	InGaN	2.9	3.9	X=0.30 Y=0.31			500	850	1270

^{*} Per NIST standards

Package Outline Dimension

Unit: mm Tolerance: +/-0.1



Absolute Maximum Ratings

(T_a 25 °C)

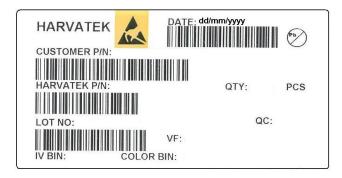
Sei	ries	P _d (mW)	I _F (mA)	I _{FP} (mA)	Ir (μA) @ V _R = 5 V	T _{OP} (°C)	T _{ST} (°C)
HT-V	/116BP	117	30	100	<1µA	-40~+85	-40~+100

^{**} Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.

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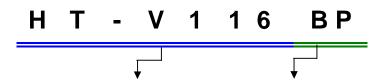


Label Spec.



■Customer P/N: To Be Defined

■ Harvatek P/N



Series Name	Emitting Color
UT V446, 2 2v4 4v0 6mm	BP:
HT-V116: 3.2x1.1x0.6mm	White

Lot No.

1 2 3 4 5 6 7 8 9 10 Ρ 1 2 2 3 0 Α D T

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
Internal Tracing Code	1: 2001 2: 2002 3: 2003 4: 2004	1: Jan. 2: Feb. 9: Sep. A: Oct. B: Nov. C: Dec.	1~31/ (30)	01~99, A,B,C	D: Milky White	T: Taped Reel

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Bin Code.

■ Iv Bin:

Color	Bin Code	Spec. Range	Bin Code	Spec. Range
	V2	500-560mcd	Y1	900-1000mcd
	W1	560-630mcd	Y2	1000-1125mcd
White	W2	630-715mcd	Z 1	1125-1270mcd
	X1	715-800mcd		
	X2	800-900mcd		

Luminous Intensity Measurement Allowance is ±10%

Color Bin:

	Rank A0					
Х	0.280	0.264	0.283	0.296		
У	0.248	0.267	0.305	0.276		
	Rank B3					
Х	0.287	0.283	0.304	0.307		
У	0.295	0.305	0.330	0.315		
	Rank B4					
Х	0.307	0.304	0.330	0.330		
У	0.315	0.330	0.360	0.339		

	Rank C0				
Х	0.330	0.330	0.361	0.356	
У	0.318	0.360	0.385	0.351	
		Ran	k B5		
Х	0.296	0.287	0.307	0.311	
У	0.276	0.295	0.315	0.294	
	Rank B6				
Х	0.311	0.307	0.330	0.330	
У	0.294	0.315	0.339	0.318	

Color Coordinates Measurement Allowance is ±0.01

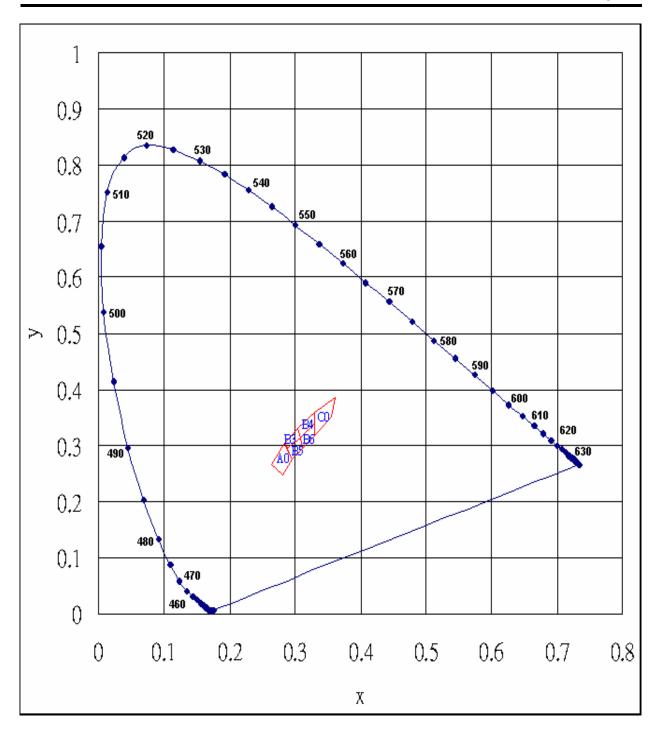
■ Vf Bin:

Color	Bin Code	Spec. Range
	G4	2.7-2.8V
	H1	2.8-2.9V
	H2	2.9-3.0V
	Н3	3.0-3.1V
White	H4	3.1-3.2V
vviille	J1	3.2-3.3V
	J2	3.3-3.4V
	J3	3.4-3.5V
	J4	3.5-3.6V
	K1	3.6-3.7V

Forward Voltage Measurement Allowance is ±0.05V

Chromaticity diagram

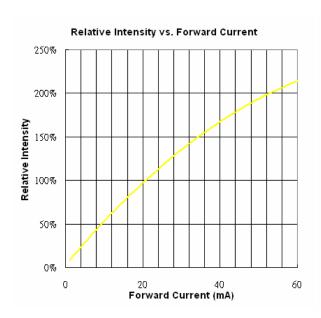
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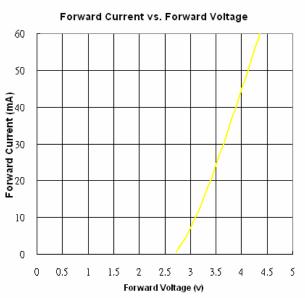


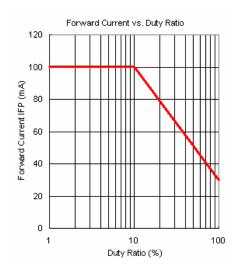
Characteristics of HT-V116BP

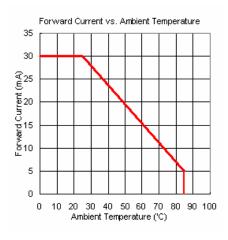
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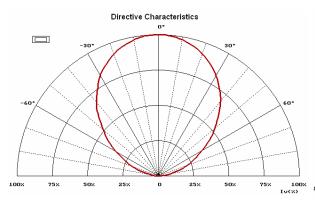


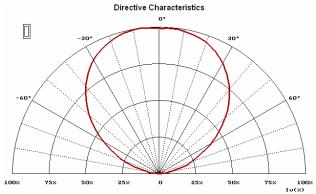






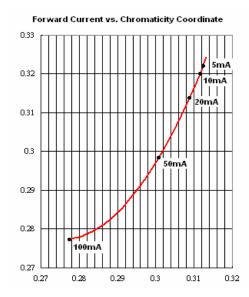


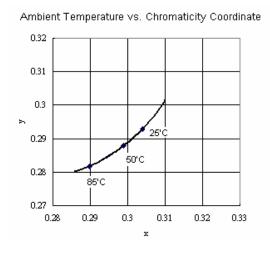


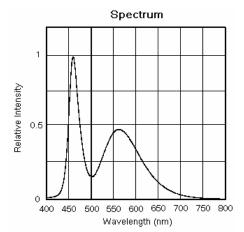


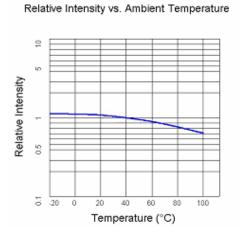
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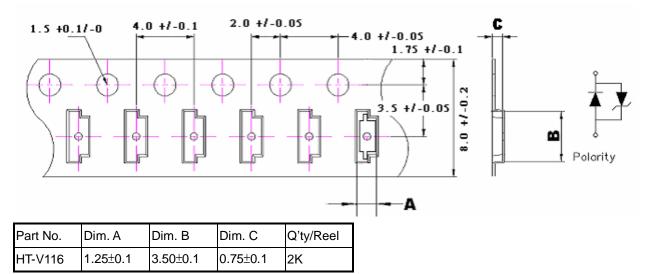




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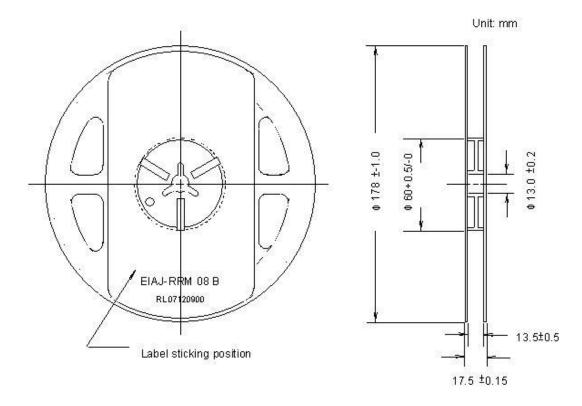


Packaging Tape, Reel, and Packing Model Tape Dimension



Unit: mm

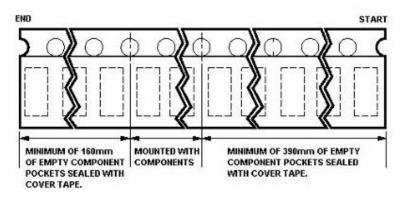
Reel Dimension



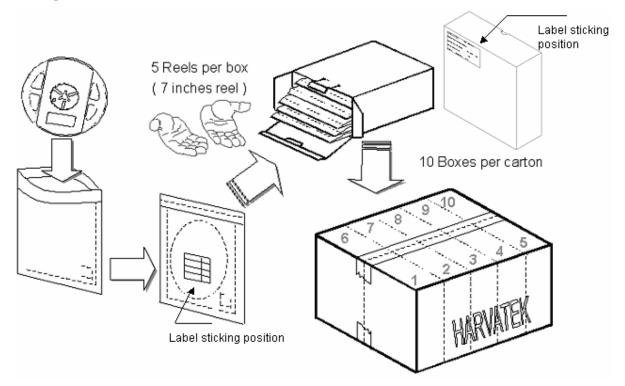
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Tape Leader and Trailer Dimension



Packing Model



5 boxes per carton is available according to shipping quantity.

Cardboard Box	Dimensions(cm)	Reel/box	Quantity/box
Size			(pcs)
Small	45 x 26 x 30	25 reels Max.	50, 000 Max
Large	50 x 46 x 30	50 reels Max.	100, 000 Max

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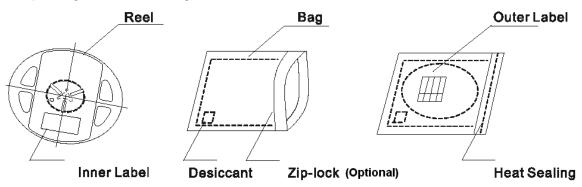


Dry Pack

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment.

By customer's requirement, we will put a humidity indicator in each moisture barrier anti-static bag before shipment.

The package is the following:



Storage

It's recommended to store the products in the following conditions:

Humidity: 60 %RH Max.

Temperature: 5 °C ~30 °C (41°F~86 °F)

- 1 Shelf life in sealed bag: 12 month at<40 °C and <90%RH. (Base on aluminum laminated moisture barrier bag.)
- 2 After the bag is opened, devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing must be:
 - 2.1 Mounted within 72 hours at factory conditions of ≤ 30 OC /60% RH, or
 - 2.2 Stored at \leq 20% RH with zip-lock sealed.

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Baking

It's recommended to bake before soldering when the pack is unsealed after 15 days. The conditions are as followings:

- a) 60 $\pm 3^{\circ}$ C×(12~24hrs) and < 5% RH, taped reel type
- b) 100±3°C×(45min~1hr), bulk type
- c) $130\pm3^{\circ}C\times(15\sim30\text{min})$, bulk type

Cautions of Pick and Place

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

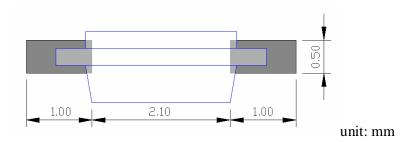
Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

PRECAUTIONS

- 1. Avoid absorbing moisture at any time during transportation or storage.
- Anti-Static process is needed especially when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a proper series current limit resistor. Avoid driving reverse voltage over the specification of LEDs when turning the unit ON/OFF.
- 4. Any application should refer to the specifications of absolute maximum ratings.
- 5. Avoid any direct contact with the viewing area.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

Soldering pattern

The dimensions of the recommended soldering pattern may not meet every user. Please confirm and study first before designing the soldering pattern in order to obtain the best performance of soldering. Recommended soldering pattern is listed below.



Soldering terminal may shift in x, y direction.

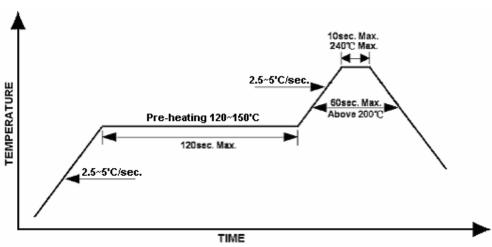
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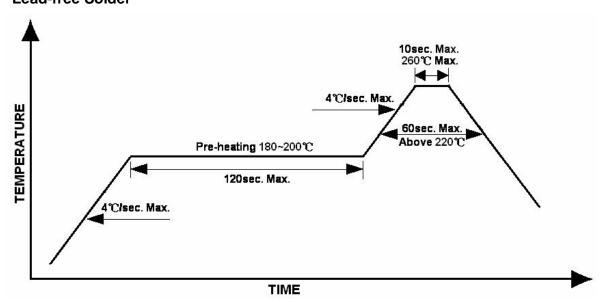
Re-flow Soldering

- ◆ Recommend tin glue specifications: Melting temperature: 178~192 °C
- ♦ Never take next process until the component is cooled down to room temperature after re-flow.
- ◆ The recommended re-flow soldering profile (measuring on the surface of the LED resin) is following:

Lead Solder



Lead-free Solder



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Rework

- ♦ Customer must finish rework within 5 sec. under 260 °C.
- ♦ The head of iron cannot touch copper foil.
- ♦ Twin-head type is preferred.

Cleaning

The conditions of cleaning after soldering:

An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.

Temperature×Time: <50 °C×30sec, or <30 °C×3min

Ultra sonic cleaning: < 15W/ bath; Bath volume: 1liter max.

Curing: 100 °C max, <3min

Do not contact with component on the assembly board.

Reliability

Test Items and results

Test Item	Standards	Conditions	Note	Failures/
	reference			Sample size
Solderability	JESD22-B102-B	Accelerated aging 155°C/ 24hrs	Over 95% area	0/22
	and CNS-5068	Tinning speed: 2.5±0.5cm/s		
		Tinning: A: 215°C/ 3 <u>+</u> 1s or B: 260°C/ 10 <u>+</u> 1s		
Resistance to soldering	JEITA ED-4701	TsId=260°C/10sec (Pre treatment 30°C/70%R.H. 168hrs)	2 times	0/100
heat	300 301			
(Reflow soldering)				
Temperature cycle	JESD-A104-A IEC 68-2-14, Nb	-40°C~25°C~85°C~25°C 15min.~5min.~15min.~5min.	300cycle	0/100
High Temp. storage	JEITA ED-4701	Ta=100°C	1000h	0/40
	200 201			
Low Temp. storage	JEITA ED-4701	Ta=-40°C	1000h	0/40
	200 202			
Temp. humidity storage	JEITA ED-4701	Ta=60°C, RH=90%	1000h	0/40
	100 103			
Vibration	JEITA ED-4701	100~2000~100HZ Sweep 4min. 200m/s ²	48min.	0/50
	400 403	3 direction, 4 cycles		
COQ			300cycle	0/100
PCT			96h	0/100
JEDEC level 1				0/100

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Steady state operation	Ta=25°C, If=20mA	1000h	0/40
High Temp. operation	Ta=55°C, If=20mA	1000h	0/40
Low Temp. operation	Ta=-40°C, lf=20mA	1000h	0/40
High Temp. & Humidity	Ta=85°C, RH=85%, If=5mA	1000h	0/40
operation 1			
High Temp. & Humidity	Ta=60°C, RH=90%, If=10mA	1000h	0/40
operation 2			

Criteria for Judging the Damage

	, , , , , , , , , , , , , , , , , , , ,			
Item	Symbol	Test Condition	Criteria for Judgement	
			Min.	Max.
Forward Voltage	Vf	I _F = 20mA	-	U.S.L* x 1.2
Luminous Intensity	lv	I _F = 20mA	L.S.L.**x 0.5	-

* U.S.L.: Upper standard level
** L.S.L.: Lower standard level

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Revision History:

Rev.	Subject (Major changes since last revision)	Date
2.0	Revise Iv Max	2006/01/18

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